# International **tor** Rectifier

### AUTOMOTIVE GRADE

# AUIRF1405ZS AUIRF1405ZL

#### Features

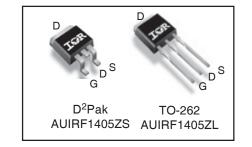
- Advanced Process Technology
- Ultra Low On-Resistance
- 175°C Operating Temperature
- Fast Switching
- Repetitive Avalanche Allowed up to Tjmax
- Lead-Free, RoHS Compliant
- Automotive Qualified \*

#### Description

Specifically designed for Automotive applications, this HEXFET® Power MOSFET utilizes the latest processing techniques to achieve extremely low onresistance per silicon area. Additional features of this design are a 175°C junction operating temperature, fast switching speed and improved repetitive avalanche rating. These features combine to make this design an extremely efficient and reliable device for use in Automotive applications and a wide variety of other applications.

#### HEXFET<sup>®</sup> Power MOSFET

	V <sub>(BR)DSS</sub>	55V	
	R <sub>DS(on)</sub> max.	<b>4.9m</b> Ω	
s	I <sub>D</sub>	150A	



G	D	S
Gate	Drain	Source

#### **Absolute Maximum Ratings**

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature ( $T_A$ ) is 25°C, unless otherwise specified.

	Parameter	Max.	Units
I <sub>D</sub> @ T <sub>C</sub> = 25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V	150	
$I_D @ T_C = 100^{\circ}C$	Continuous Drain Current, V <sub>GS</sub> @ 10V	110	A
I <sub>DM</sub>	Pulsed Drain Current ①	600	7
$P_{D} @ T_{C} = 25^{\circ}C$	Power Dissipation	230	W
	Linear Derating Factor	1.5	W/°C
V <sub>GS</sub>	Gate-to-Source Voltage	± 20	V
E <sub>AS</sub>	Single Pulse Avalanche Energy (Thermally Limited) 2	270	mJ
E <sub>AS</sub> (tested)	Single Pulse Avalanche Energy Tested Value 6	420	7
I <sub>AR</sub>	Avalanche Current ①	See Fig.12a, 12b, 15, 16	A
E <sub>AR</sub>	Repetitive Avalanche Energy ©		mJ
TJ	Operating Junction and	-55 to + 175	
T <sub>STG</sub>	Storage Temperature Range		°C
	Soldering Temperature, for 10 seconds (1.6mm from case)	300	1
	Mounting Torque, 6-32 or M3 screw	10 lbf•in (1.1N•m)	

#### **Thermal Resistance**

	Parameter	Тур.	Max.	Units
R <sub>0JC</sub>	Junction-to-Case		0.65	°C/W
R <sub>θJA</sub>	Junction-to-Ambient (PCB Mount, steady state)		40	

 $<sup>\</sup>mathsf{HEXFET}^{\textcircled{B}}$  is a registered trademark of International Rectifier.

<sup>\*</sup>Qualification standards can be found at http://www.irf.com/

	Parameter	Min.	Тур.	Max.	Units	Conditions
V <sub>(BR)DSS</sub>	Drain-to-Source Breakdown Voltage	55			V	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250µA
$\Delta V_{(BR)DSS} / \Delta T_J$	Breakdown Voltage Temp. Coefficient		0.049		V/°C	Reference to $25^{\circ}$ C, I <sub>D</sub> = 1mA
R <sub>DS(on)</sub>	Static Drain-to-Source On-Resistance		3.7	4.9	mΩ	V <sub>GS</sub> = 10V, I <sub>D</sub> = 75A ③
V <sub>GS(th)</sub>	Gate Threshold Voltage	2.0		4.0	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
gfs	Forward Transconductance	88			S	V <sub>DS</sub> = 25V, I <sub>D</sub> = 75A
I <sub>DSS</sub>	Drain-to-Source Leakage Current			20	μA	$V_{DS} = 55V, V_{GS} = 0V$
				250	1	V <sub>DS</sub> = 55V, V <sub>GS</sub> = 0V, T <sub>J</sub> = 125°C
I <sub>GSS</sub>	Gate-to-Source Forward Leakage			200	nA	V <sub>GS</sub> = 20V
-	Gate-to-Source Reverse Leakage			-200		V <sub>GS</sub> = -20V
Dynamic E	lectrical Characteristics @ T <sub>J</sub> =	25°C	(unle	ss oth	herwis	
Qg	Total Gate Charge		120	180	[	I <sub>D</sub> = 75A
Q <sub>gs</sub>	Gate-to-Source Charge		31		nC	$V_{DS} = 44V$
Q <sub>gd</sub>	Gate-to-Drain ("Miller") Charge		46		1	V <sub>GS</sub> = 10V ③
t <sub>d(on)</sub>	Turn-On Delay Time		18			$V_{DD} = 25V$
t <sub>r</sub>	Rise Time		110		1	I <sub>D</sub> = 75A
t <sub>d(off)</sub>	Turn-Off Delay Time		48		ns	$R_{G} = 4.4\Omega$
t <sub>f</sub>	Fall Time		82		1	V <sub>GS</sub> = 10V ③
L <sub>D</sub>	Internal Drain Inductance		4.5			Between lead, p
					nH	6mm (0.25in.)
L <sub>s</sub>	Internal Source Inductance		7.5		1	from package
						and center of die contact
C <sub>iss</sub>	Input Capacitance		4780			$V_{GS} = 0V$
C <sub>oss</sub>	Output Capacitance		770		1	$V_{DS} = 25V$
C <sub>rss</sub>	Reverse Transfer Capacitance		410		pF	f = 1.0 MHz
C <sub>oss</sub>	Output Capacitance		2730		1	$V_{GS} = 0V, V_{DS} = 1.0V, f = 1.0MHz$
C <sub>oss</sub>	Output Capacitance		600		1	$V_{GS} = 0V, V_{DS} = 44V, f = 1.0MHz$
C <sub>oss</sub> eff.	Effective Output Capacitance		910		1	$V_{GS} = 0V, V_{DS} = 0V \text{ to } 44V $
Diode Cha	racteristics					
	Parameter	Min.	Тур.	Max.	Units	Conditions
ا <sub>S</sub>	Continuous Source Current			75		MOSFET symbol
	(Body Diode)				Α	showing the
I <sub>SM</sub>	Pulsed Source Current			600	]	integral reverse
	(Body Diode)					p-n junction diode.
V <sub>SD</sub>	Diode Forward Voltage			1.3	V	T <sub>J</sub> = 25°C, I <sub>S</sub> = 75A, V <sub>GS</sub> = 0V ③
t <sub>rr</sub>	Reverse Recovery Time		30	46	ns	T <sub>J</sub> = 25°C, I <sub>F</sub> = 75A, V <sub>DD</sub> = 25V
Q <sub>rr</sub>	Reverse Recovery Charge		30	45	nC	di/dt = 100A/µs ③
t <sub>on</sub>	Forward Turn-On Time	Intrinsio	turn-or	time is	negligib	le (turn-on is dominated by LS+LD)

#### Static Electrical Characteristics @ T<sub>J</sub> = 25°C (unless otherwise specified)

#### Notes:

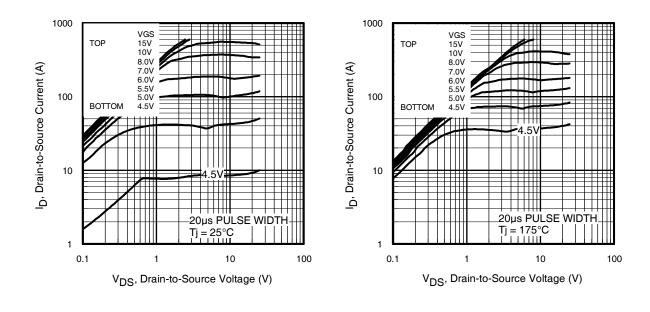
- Repetitive rating; pulse width limited by max. junction temperature. (See fig. 11).
- ③ Pulse width  $\leq$  1.0ms; duty cycle  $\leq$  2%.
- 4 C\_{oss} eff. is a fixed capacitance that gives the same charging time as C\_{oss} while V\_{DS} is rising from 0 to 80% V\_{DSS}.
- ⑤ Limited by T<sub>Jmax</sub>, see Fig.12a, 12b, 15, 16 for typical repetitive avalanche performance.
- black This value determined from sample failure population, starting T\_J = 25°C, L = 0.10mH, R\_G = 25\Omega, I\_{AS} = 75A, V\_{GS} =10V.
- ⑦ This is applied to D<sup>2</sup>Pak, when mounted on 1" square PCB (FR-4 or G-10 Material). For recommended footprint and soldering techniques refer to application note #AN-994.

### Qualification Information<sup>†</sup>

		Automotive			
		(per AEC-Q101) <sup>††</sup>			
		Comments: This part number(s) passed Automotive qualification. IR's Industrial and Consumer qualification level is granted by extension of the higher Automotive level.			
Maistura Sansitivity	Moisture Sensitivity Level		N/A		
Moisture Sensitivity			D <sup>2</sup> Pak MSL1		
	Machine Model	Class M4 (425V)			
		AEC-Q101-002			
	Human Body Model	Class H1C (2000V)			
ESD			AEC-Q101-001		
	Charged Device	Class C5 (1125V)			
	Model	AEC-Q101-005			
RoHS Compliant		Yes			

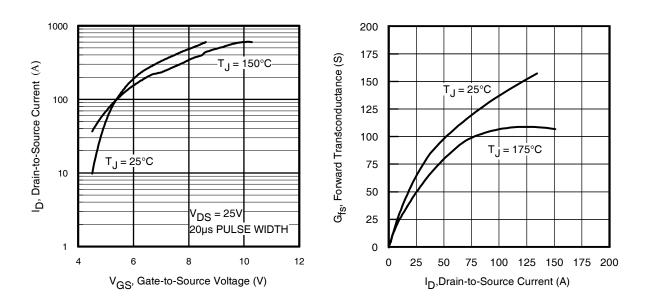
† Qualification standards can be found at International Rectifier's web site: http://www.irf.com/

**††** Exceptions to AEC-Q101 requirements are noted in the qualification report.



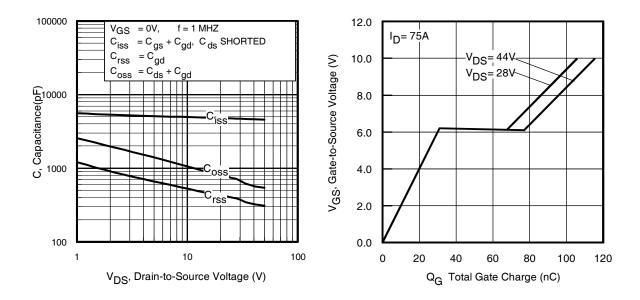
#### Fig 1. Typical Output Characteristics





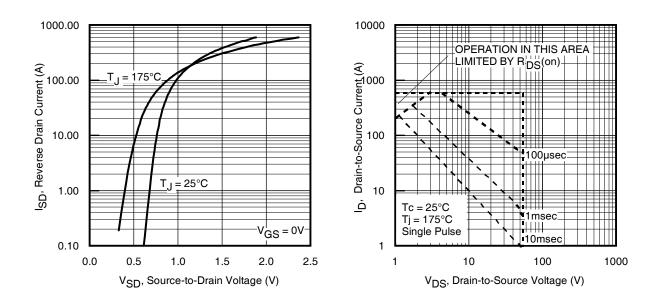
#### Fig 3. Typical Transfer Characteristics

Fig 4. Typical Forward Transconductance vs. Drain Current



#### Fig 5. Typical Capacitance vs. Drain-to-Source Voltage

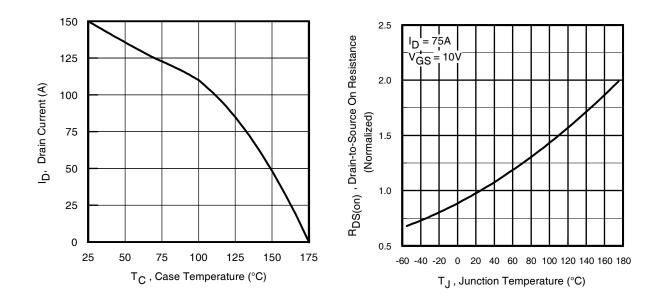




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Fig 7. Typical Source-Drain Diode Forward Voltage

Fig 8. Maximum Safe Operating Area



#### Fig 9. Maximum Drain Current vs. Case Temperature



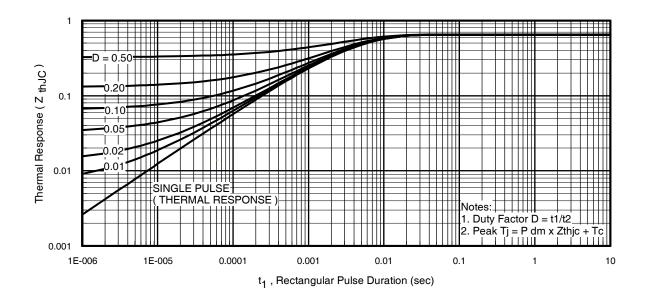


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

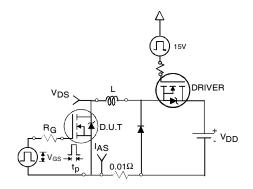


Fig 12a. Unclamped Inductive Test Circuit

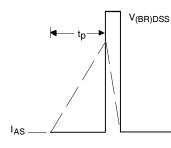
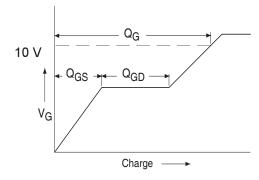
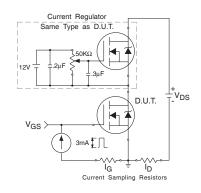


Fig 12b. Unclamped Inductive Waveforms







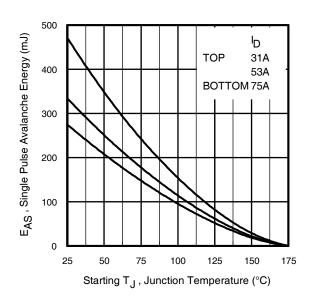


Fig 12c. Maximum Avalanche Energy vs. Drain Current

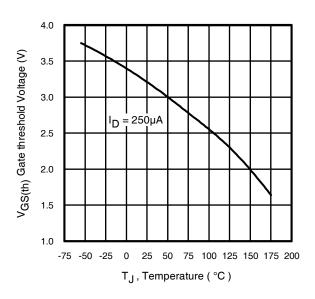


Fig 14. Threshold Voltage vs. Temperature

**Fig 13b.** Gate Charge Test Circuit www.irf.com

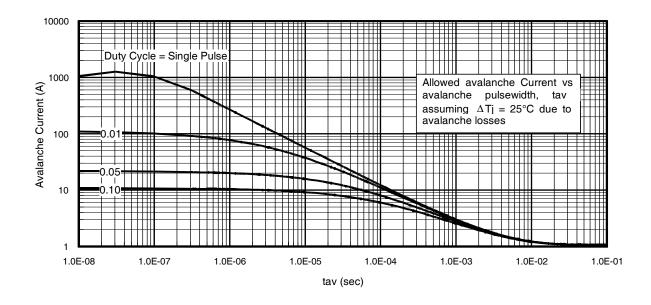
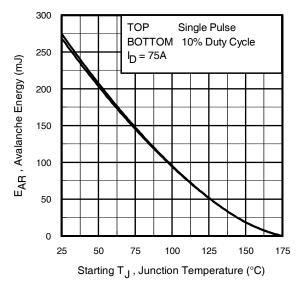


Fig 15. Typical Avalanche Current vs.Pulsewidth



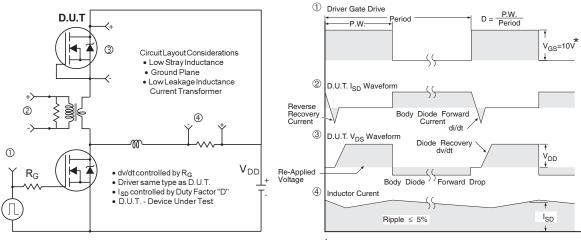
## Fig 16. Maximum Avalanche Energy vs. Temperature

Notes on Repetitive Avalanche Curves , Figures 15, 16: (For further info, see AN-1005 at www.irf.com) 1. Avalanche failures assumption:

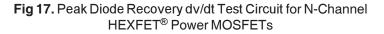
Purely a thermal phenomenon and failure occurs at a temperature far in excess of  $T_{jmax}$ . This is validated for every part type.

- 2. Safe operation in Avalanche is allowed as long  $asT_{jmax}$  is not exceeded.
- 3. Equation below based on circuit and waveforms shown in Figures 12a, 12b.
- 4. P<sub>D (ave)</sub> = Average power dissipation per single avalanche pulse.
- 5. BV = Rated breakdown voltage (1.3 factor accounts for voltage increase during avalanche).
- 6.  $I_{av}$  = Allowable avalanche current.
- 7.  $\Delta$ T = Allowable rise in junction temperature, not to exceed T<sub>jmax</sub> (assumed as 25°C in Figure 15, 16).
  - $t_{av}$  = Average time in avalanche.
  - D = Duty cycle in avalanche =  $t_{av} \cdot f$
  - $Z_{thJC}(D, t_{av})$  = Transient thermal resistance, see figure 11)

$$\begin{split} P_{D~(ave)} &= 1/2~(~1.3{\cdot}BV{\cdot}I_{av}) = {{\bigtriangleup}T/~Z_{thJC}}\\ I_{av} &= 2{{\bigtriangleup}T/~[1.3{\cdot}BV{\cdot}Z_{th}]}\\ E_{AS~(AR)} &= P_{D~(ave)}{\cdot}t_{av} \end{split}$$



\*  $V_{\rm GS}$  = 5V for Logic Level Devices



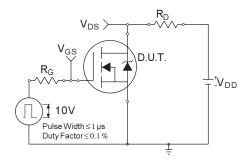


Fig 18a. Switching Time Test Circuit

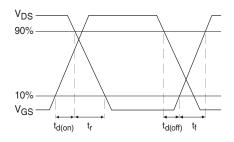
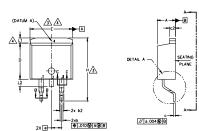


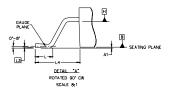
Fig 18b. Switching Time Waveforms

### D<sup>2</sup>Pak (TO-263AB) Package Outline

Dimensions are shown in millimeters (inches)







S Y M	DIMENSIONS					
B	MILLIM	ETERS	INC	HES	N O T E S	
L	MIN.	MAX.	MIN.	MAX.	S	
A	4.06	4,83	.160	.190		
A1	0.00	0.254	.000	.010		
ь	0.51	0.99	.020	.039		
b1	0.51	0.89	.020	.035	5	
b2	1,14	1.78	.045	.070		
ьз	1,14	1.73	.045	.068	5	
с	0.38	0.74	.015	.029		
c1	0.38	0.58	.015	.023	5	
c2	1,14	1.65	.045	.065		
D	8.38	9.65	.330	.380	3	
D1	6.86	-	.270		4	
E	9.65	10.67	.380	.420	3,4	
E1	6.22	-	.245		4	
e	2.54	BSC	.100	BSC		
н	14.61	15.88	.575	.625		
L	1,78	2.79	.070	.110		
L1	-	1.65	-	.066	4	
L2	-	1.78	-	.070		
L3	0.25	BSC	.010	BSC		
L4	4.78	5.28	.188	.208		

LATING LATING

LEAD ASSIGNMENTS	
DIODES	
1 ANODE (TWO DIE) 2, 4 CATHODE 3 ANODE	/ OPEN (ONE DIE)
HEXFET	IGBTs. CoPACK
1 GATE 2, 4 DRAIN 3 SOURCE	1 GATE 2. 4 COLLECTO 3 EMITTER

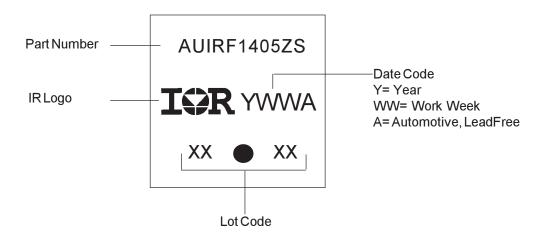
NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994
2. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
▲ DIMENSION D & E DO NOT INCLUDE MOLD FLASH, MOLD FLASH SHALL NOT EXCEED 0.127 [.0097] PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY AT DATUM H.
A THERWAL PAD CONTOUR OPTIONAL WITHIN DIMENSION E, LI, DI & EI.
S DIMENSION 61 AND c1 APPLY TO BASE METAL ONLY.
C DATUM A A D TO DE DETERMÉNER AT DATUM DIANE I

6. DATUM A & B TO BE DETERMINED AT DATUM PLANE H

7. CONTROLLING DIMENSION: INCH.

8. OUTLINE CONFORMS TO JEDEC OUTLINE TO-263AB.

### D<sup>2</sup>Pak (TO-263AB) Part Marking Information

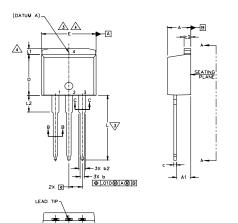


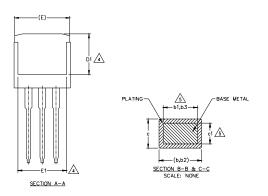
International **TOR** Rectifier

# AUIRF1405ZS/L

### TO-262 Package Outline

Dimensions are shown in millimeters (inches)



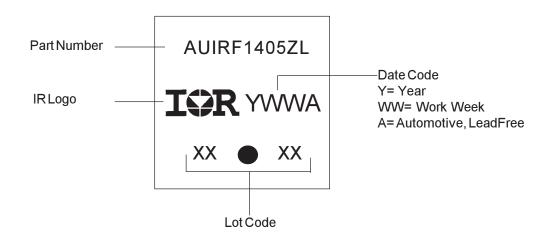


C					
S Y M		N			
B	MILLIM	ETERS	TERS INCHES		O T E S
B O L	MIN.	MAX.	MIN.	MAX.	L S
A	4.06	4.83	.160	.190	
A1	2.03	3.02	.080	.119	
ь	0.51	0.99	.020	.039	
ь1	0.51	0.89	.020	.035	5
Ь2	1.14	1.78	.045	.070	
Ь3	1.14	1.73	.045	.068	5
с	0.38	0.74	.015	.029	
c1	0.38	0.58	.015	.023	5
c2	1.14	1.65	.045	.065	
D	8.38	9.65	.330	.380	3
D1	6.86	_	.270		4
E	9.65	10.67	.380	.420	3,4
E1	6.22	-	.245		4
е	2.54	BSC	.100	.100 BSC	
L	13.46	14.10	.530	.555	
∟1	-	1.65	-	.065	4
L2	3.56	3.71	.140	.146	

ΝΟΤΟ 1. DM/SOUND AND TOLERMONG PER ASK 11454-1934 2. DM/SOUND AND TOLERMONG PER ASK 11454-1944 2. DM/SOUND AR 5 DO NOT RELIES (NOT TASK) MULT DY EXCEED 1. DM/SOUND AR 5 DO NOT RELIES (NOT TASK) MULT DY EXCEED 1. TOTAL SOUND AR 5 DO NOT AND AR MARK AND TOLES CONTRACTOR OF RAISE DOWN (MINING DARK MARKAND AT THE DYNGST) CONTRACTOR OF RAISE DOWN (MINING DARKSON E. L1. DI & E1. DYNGST) DARK DARKSON DOWN OF DARK MARKAND AR 2. CONTRACTOR DOWN (MINING DARKSON E. L1. DI & E1. DARK DARKSON DOWN OF DARK AND ARCTOR DARKSON 2. CONTRACTOR DOWN OF ACTOR DARKSON (DARKSON DIRKON) MARK DARKSON DIRK DARK DIRK ACTOR DARKSON (DARKSON 1. CONTRACTOR DARKSON DIRK DARKSON DIRK DARKSON 1. CONTRACTOR 2. CONTRACTOR 3. CONTRACTOR



### TO-262 Part Marking Information

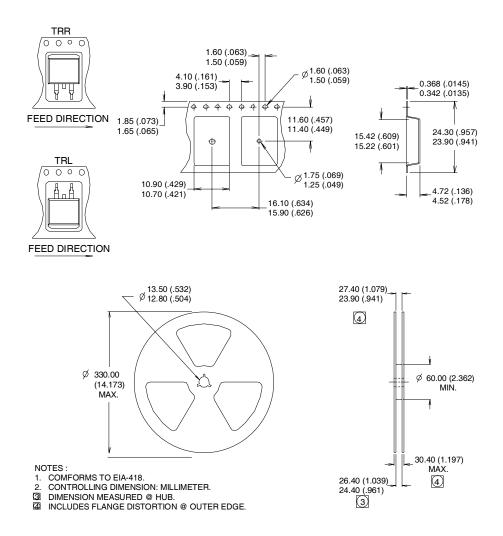


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### D<sup>2</sup>Pak Tape & Reel Information

Dimensions are shown in millimeters (inches)



### Ordering Information

Base part	Package Type	Standard Pack		Complete Part Number
		Form	Quantity	
AUIRF1405ZL	TO-262	Tube	50	AUIRF1405ZL
AUIRF1405ZS	D2Pak	Tube	50	AUIRF1405ZS
		Tape and Reel Left	800	AUIRF1405ZSTRL
		Tape and Reel Right	800	AUIRF1405ZSTRR

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